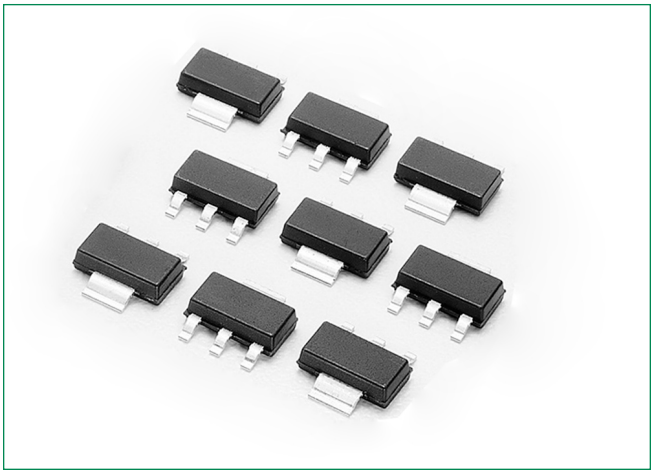
NYC222, NYC226, NYC228



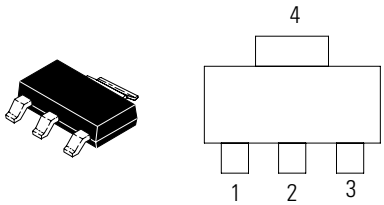
Description

Designed and tested for repetitive peak operation required for CD ignition, fuel ignitors, flash circuits, motor controls and low-power switching applications.

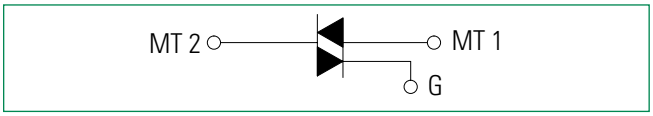
Features

- Blocking Voltage to 600 V
- High Surge Current – 15 A
- Very Low Forward "On" Voltage at High Current
- Low-Cost Surface Mount SOT–223 Package
- These are Pb–Free Devices

Pin Out



Functional Diagram



Additional Information

Datasheet | **Resources** | **Samples**

© 2019 Littelfuse, Inc.
Specifications are subject to change without notice.
Revised: 07/25/19

Maximum Ratings (T_J = 25°C unless otherwise noted)

Rating		Symbol	Value	Unit
Peak Repetitive Off–State Voltage (Note 1) (R_{GK} = I_K, T_J – 40 to +110°C, Sine Wave, 50 to 60 Hz)	NYC222 NYC226 NYC228	V_{DRM}, V_{RRM}	50 400 600	V
On-State RMS Current (180° Conduction Angles; T_C = 80°C)		$I_{T\ (RMS)}$	1.5	A
Average On–State Current, (T_C = 65°C, f = 60 Hz, Time = 1 sec)		$I_{T\ (RMS)}$	2.0	A
Peak Non-repetitive Surge Current, @T_A = 25°C, (1/2 Cycle, Sine Wave, 60 Hz)		I_{TSM}	15	A
Circuit Fusing Considerations (t = 8.3 ms)		I^2t	0.9	A2s
Forward Peak Gate Power (Pulse Width ≤ 1.0 sec, T_A = 25°C)		P_{GM}	0.5	W
Forward Average Gate Power (t = 8.3 msec, T_A = 25°C)		$P_{GM\ (AV)}$	0.1	W
Forward Peak Gate Current (Pulse Width ≤ 1.0 s, T_A = 25°C)		I_{FGM}	0.2	A
Reverse Peak Gate Voltage (Pulse Width ≤ 1.0 µs, T_A = 25°C)		V_{RGM}	5.0	V
Operating Junction Temperature Range @ Rated V_{RRM} and V_{DRM}		T_J	-40 to +110	°C
Storage Temperature Range		T_{stg}	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thermal Characteristics

Rating	Symbol	Value	Unit
Thermal Resistance, Junction–to–Ambient PCB Mounted	$R_{\theta JA}$	156	mW
Thermal Resistance, Junction–to–Tab Measured on MT2 Tab Adjacent to Epoxy	$R_{\theta JT}$	25	°C/W
Maximum Device Temperature for Soldering Purposes for 10 Secs Maximum	T_L	260	°C

Electrical Characteristics - OFF (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
†Peak Repetitive Blocking Current (V_{AK} = V_{DRM} = V_{RRM}; Gate Open)	T_J = 25°C	I_{DRM}, I_{RRM}	-	-	1.0	µA
	T_J = 110°C		-	-	200	mA

Electrical Characteristics - ON (T_J = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Typ	Max	Unit
Peak Forward On-State Voltage (Note 2) (I_{TM} = 2.2 A Peak)		V_{TM}	–	1.2	1.7	V
HGate Trigger Current (Note 3) (V_D = 12 V, R_L = 100 Ω, T_C = 25°C)	T_C = 25°C	I_{GT}	–	30	200	µA
	T_C =–40°C		–	–	500	
Gate Trigger Voltage (dc) (Note 3) (V_{AK} = 7 Vdc, R_L = 100Ω)	T_C = 25°C	V_{GT}	–	–	0.8	V
	T_C =–40°C		–	–	1.2	
Gate Non–Trigger Voltage (V_{AK} = V_{DRM}, R_L = 100 Ω)	T_C = 110°C	V_{GD}	0.1	–	–	V
Holding Current (V_{AK} = 12 V, R_{GK} = 1000 Ω) Initiating Current = 200 mA	T_C = 25°C	I_H	–	2.0	5.0	V
	T_C =–40°C		–	–	10	

© 2019 Littelfuse, Inc.
Specifications are subject to change without notice.
Revised: 07/25/19

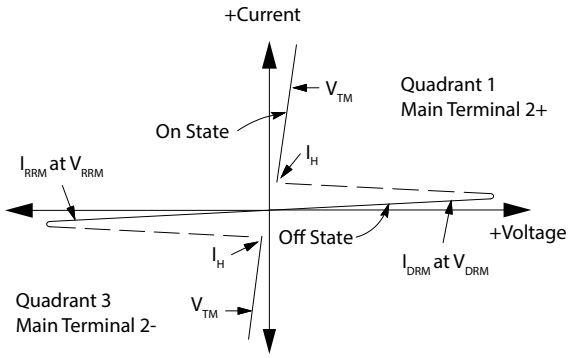
Dynamic Characteristics

Characteristic	Symbol	Min	Typ	Max	Unit
Critical Rate-of-Rise of Off State Voltage (T_C = 110°C)	dv/dt	–	25	–	V/µs
Critical Rate of Rise of On–State Current (T_C = 110°C, I_G = 2 x I_{GT}, R_{GK} = 1 kΩ)	di/dt	–	20	–	A/µs

2. Pulse Width =1.0 ms, Duty Cycle ≤ 1%.
3. RGK Current not included in measurement.

Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
I_H	Holding Current



© 2019 Littelfuse, Inc.
Specifications are subject to change without notice.

Current Derating

Figure 1. Maximum Case Temperature

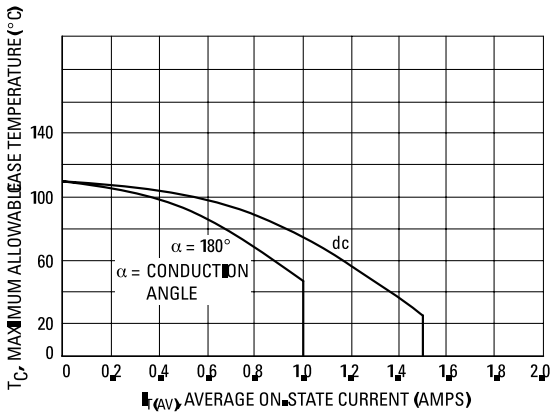


Figure 2. Maximum Ambient Temperature

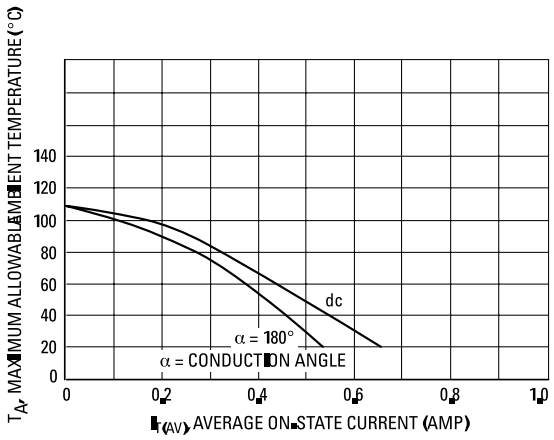


Figure 3. Typical Forward Voltage

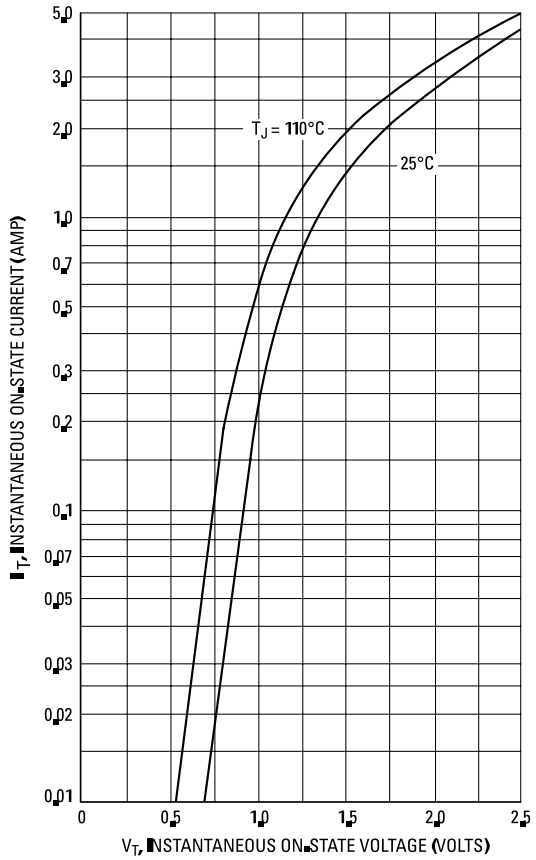
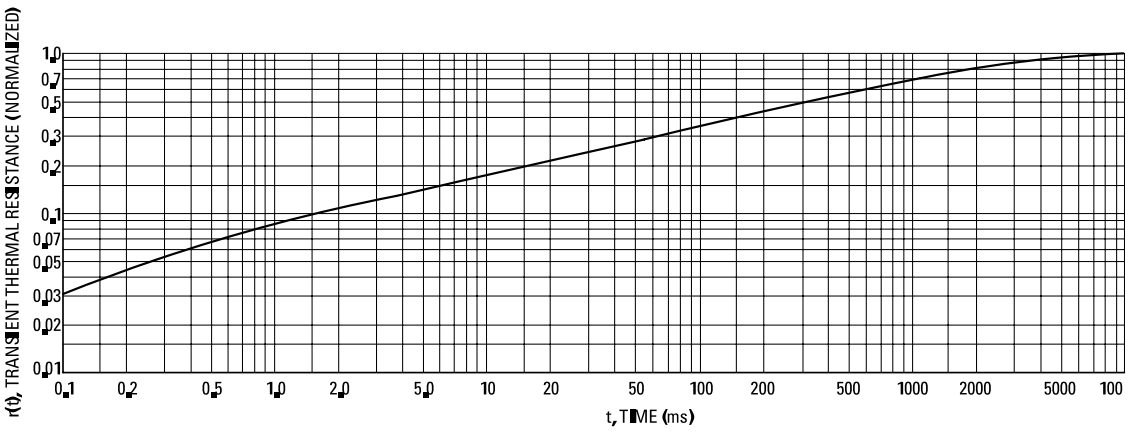


Figure 4. Thermal Response



© 2019 Littelfuse, Inc.
Specifications are subject to change without notice.
Revised: 07/25/19

Figure 5. Typical Gate Trigger Voltage

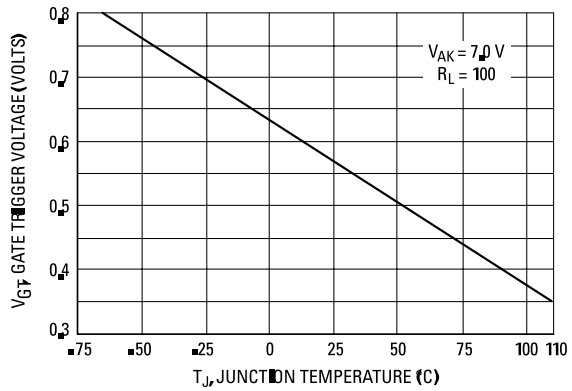


Figure 6. Typical Gate Trigger Current

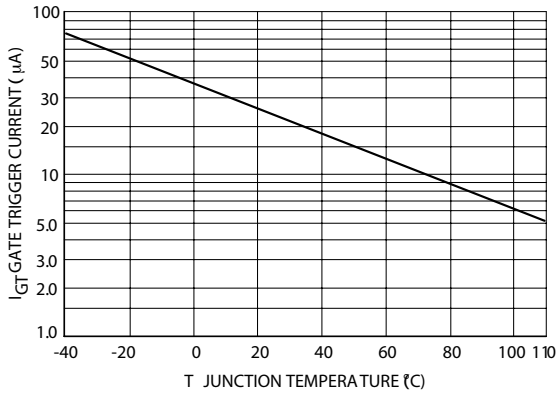


Figure 7. Typical Holding Current

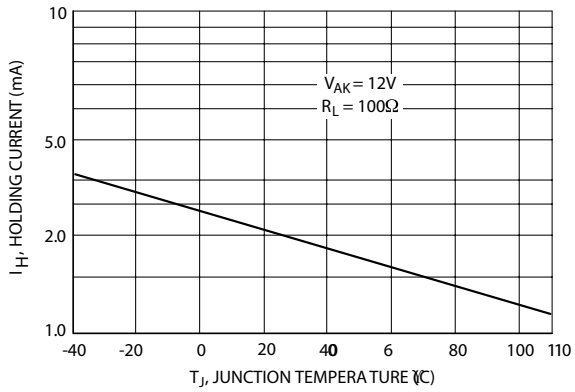
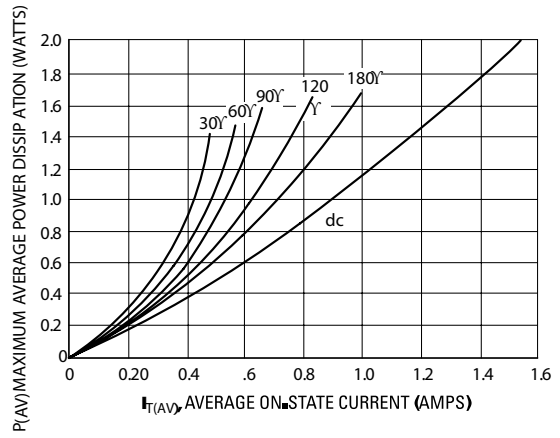


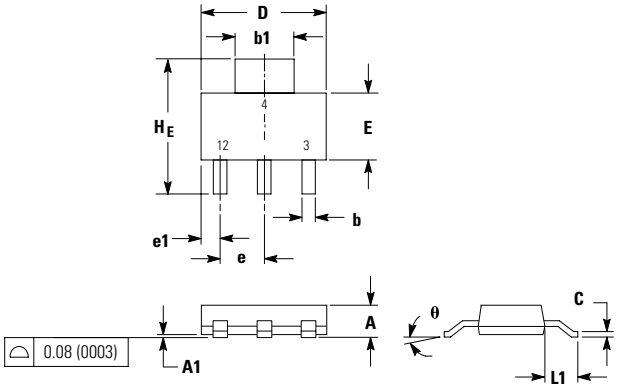
Figure 8. Power Dissipation



© 2019 Littelfuse, Inc.
Specifications are subject to change without notice.

Thyristors
Surface Mount – 400V – 600V > NYC222, NYC226, NYC228

Dimensions

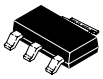


Dim	Inches			Millimeters		
	Min	Nom	Max	Min	Nom	Max
A	---	---	0.071	---	---	1.80
A1	0.001	0.003	0.005	0.02	0.07	0.13
b	0.026	0.030	0.033	0.66	0.75	0.84
b1	0.114	0.118	0.122	2.90	3.00	3.10
c	0.009	0.011	0.014	0.23	0.29	0.35
D	0.260	0.260	0.264	6.60	6.60	6.71
E	0.130	0.138	0.146	3.30	3.50	3.70
e	---	0.091	---	---	2.30	---
e1	0.030	0.037	0.045	0.75	0.95	1.15
L1	0.059	0.069	0.079	1.50	1.75	2.00
HE	0.268	0.276	0.283	6.80	7.00	7.20
ø	0°	---	10°	0°	---	10°

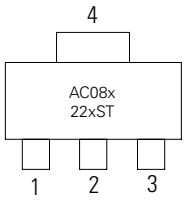
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

Pin Assignment	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

Part Marking System

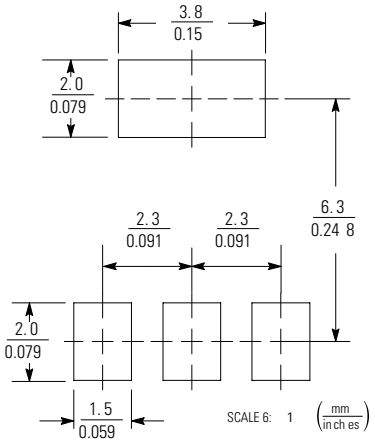


SOT-223
Case 318E
Style 11



22xST =Device Code
x =D, M, or N
Y =Year
M =Month
A =Assembly Site
XX =Lot Serial Code
G =Pb-Free Package

Soldering Footprint



Ordering Information

Device	Package	Shipping
NYC222STT1G	SOT-223 (Pb-Free)	1000/Tape & Reel
NYC226STT1G	SOT-223 (Pb-Free)	
NYC228STT1G	SOT-223 (Pb-Free)	

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at: www.littelfuse.com/disclaimer-electronics

© 2019 Littelfuse, Inc.
Specifications are subject to change without notice.
Revised: 07/25/19